

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jiang et al. Art Unit: 1765
Serial No.: 09/966,605 Examiner: Vinh, L.
Filing Date: 09/28/2001 Docket No.: TI-31462
Title: IN-SITU PLASMA ASH/TREATMENT AFTER VIA ETCH OF
LOW-K FILMS FOR POISON-FREE DUAL DAMASCENE
TRENCH PATTERNING

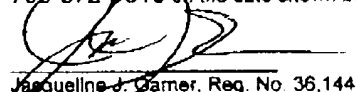
REQUEST FOR EXTENSION OF TIME

Commissioner of Patents
PO Box 1450
Alexandria, VA 22313-1450

Dear Sir:

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by
facsimile to the U.S. Patent and Trademark Office at
703-872-9318 on the date shown below:


Jacqueline J. Garner, Reg. No. 36,144

September 9, 2003
Date

Pursuant to 37 CFR 1.136(a), Applicant(s) respectfully petitions the Commissioner
for an extension of the shortened statutory period for response in the above-identified
Application.

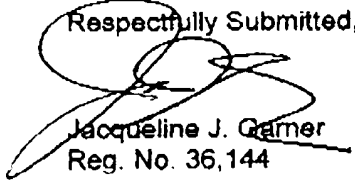
The fee for this extension is indicated below:

- ☐ One Month (\$110)
☒ Two Months (\$410)
☐ Three Months (\$930)
☐ Four Months (\$1,450)

Please charge the fee to deposit account no. 20-0668. Any further necessary
extension of time is hereby requested. Charge any and all fees to deposit account no. 20-
0668. An original and two copies of this sheet are enclosed.

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Respectfully Submitted,


Jacqueline J. Garner
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